

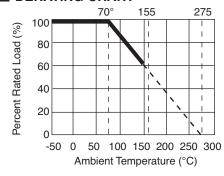
Cement Power Resistors (RoHS Compliant)

PRM-RC Series

■ FEATURES

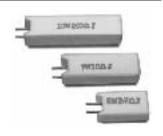
- 5% tolerance
- · Exceptionally small, sturdy, and reliable
- · Sealed with a special cement
- · Excellent moisture resistance
- · High temperature stability
- · Ceramic flame retardant package
- · Recommended wash method is alcohol

DERATING CHART

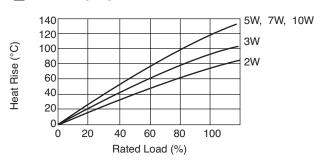


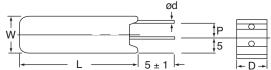
8



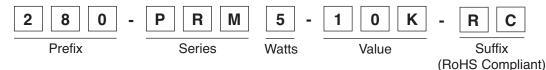


■ HEAT RISE CHART





■ PART NUMBERING SYSTEM



■ SERIES, WATTAGE, VALUE RANGE, AND DIMENSIONS

Series	Watts (W)	Range of \	Values (Ω)	Dimensions (mm)					
Series	walls (w)	Wirewound	Power Film	W ±1	D ±1	L ±1	ød ±0.05	P ±1	
* PRM	5	0.1 ~ 47	48 ~ 100K	12.5	9	25	0.75	5	
PRM	7	0.1 ~ 680	681 ~ 200K	12.5	9	38	0.75	5	
PRM	10	0.1 ~ 910	911 ~ 200K	12.5	9	50	0.75	5	

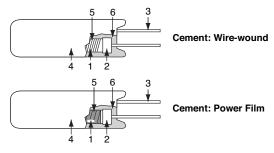
^{*} Leads are centered

STANDARD STOCKED VALUES (Ω) All standard E-24 values not listed are available special order.

0.1	0.3	0.51	1.0	3.0	6.8	15	33	56	68	75	100	150	200	300	330	470	680	1K	2K	4.7K	10K
0.22	0.47	0.68	2.2	4.7	10	20	47														

CONSTRUCTION

No.	Subpart Name	Material	Material Generic Name			
1	Body	Rod Type Ceramics	Al ₂ O ₃ , SiO ₂			
2	End Cap	Tin plated iron surface	Tin : 5%, Iron : 95%			
3	Lead	Annealed copper wire	Tin-Coated Copper wire			
		(Electrosolder plated surface) Pb Free				
4	Ceramic Case	Ceramic	Al ₂ O ₃ , SiO ₂			
5	Resistance wire	Ni-Cr Alloy	Ni-Cr Alloy			
	Resistance Film	Metal Oxide Film	Metal Oxide Film			
6	Filling Materials	Quartz mixed sand	SiO2			



Specifications are subject to change without notice. No liability or warranty implied by this information. Environmental compliance based on producer documentation.

XICON

Cement Power Resistors (RoHS Compliant)

PRM-RC Series

■ CHARACTERISTICS

Characteristics	Limits		Test Methods (JIS C 5201-1)					
Temperature coefficient	± 350 PPM / °C Max. <20Ω ± 400 PPM / °C		5.2 Natural resistance change per temp. degree centigrade. R2-R1 x10° (PPM / °C) R1(t2-t1) R1: Resistance value at room temperature (t1) R2: Resistance value at room temp. plus 100 °C (t2)					
Dielectric withstanding voltage	No evidence of flashov mechanical damage, a or insulation break dow	rcing	5.7 Resistors shall be clamped in the trough of a 90° metallic V-block and shall be tested at AC potential respectively for 60 +10/ -0 secs.					
			7.4 Resistance change after continuous 5 cycles for duty shown below:					
Temperature	Resistance change rate	e is	Step Temperature Time					
cycling	± (2% + 0.05Ω) Max. v	vith no	1	-55 °C ± 3 °C	30 mins			
	evidence of mechanica	al damage	2	Room temp.	10 ~ 15 mins			
			3	+155 °C ± 2 °C	30 mins			
			4	Room temp.	10 ~ 15 mins			
Short time overload	Resistance change rate \pm (5% + 0.05 Ω) Max. we evidence of mechanical	vith no	5.5 Permanent resistance change after the application of a potential of 2.5 times RCWV for 5 seconds					
	Resistance value	Δ R/R	7.9 Resistance	change after 1,000 hours				
	Wire-wound	± 5%	operating at RCWV with duty cycle of					
Load life in humidity	pad life in Power film: <100 K Ω $\pm 5\%$ (1.5 hours "or			on", 0.5 hour "off") in a humidity test ntrolled at 40 $^{\circ}$ C \pm 2 $^{\circ}$ C and 90 to 95 $^{\circ}$				
	Resistance value	Δ R/R	7.10 Permanent					
Load life	Wire-wound	± 5%	1,000 hours operating at RCWV with duty cycle of (1.5 hours "on", 0.5 hour "off") at 70 $^{\circ}$ C ±2 $^{\circ}$ C					
	Power film: <100KΩ	± 5%						
	>100KΩ	± 10%						
Terminal strength	No evidence of mecha damage	nical	6.1 Direct load: Resistance to a 2.5 kgs direct load for 10 secs. in the direction of the longitudinal axis of the terminal leads Twist test: Terminal leads shall be bent through 90 ° at a point of about 6mm from the body of the resistor and shall be rotated through 360° about the original axis of the bent terminal in alternating direction for a total of 3 rotations					
Resistance to soldering heat	Resistance change rate \pm (1% + 0.05 Ω) Max. we evidence of mechanical	vith no	6.4 Permanent resistance change when leads immersed to 3.2 to 4.8 mm from the body in $350 ^{\circ}\text{C} \pm 10 ^{\circ}\text{C}$ solder for 3 ± 0.5 secs.					
Solderability	95 % coverage Min.	-	6.5 The area covered with a new , smooth clean , shiny and continuous surface free from concentrated pinholes. Test temp. of solder : 245 °C ± 3 °C Dwell time in solder : 2 ~ 3 seconds					